

July 10th 2023

Tender for a Supply and installation of a Vacuum Soldering Bonder

This is a Global Tender Enquiry, for the supply and installation of a Vacuum Soldering Bonder for CeNSE, IISc Bangalore.

Last Date of Submission: 14th July 2023

Corrigendum

Technical Specification

- 1. Au80Sn20 Preform (Width: 25.4mm, thickness: 0.025 mm) length 5 mts
- 2. Au80Sn20 Preform -(Width: 25.4mm, thickness: 0.050 mm) length 5 mts

New Last Date of Submission: 21st July 2023, 5:30 pm

Yours Sincerely,

Prosenjit Sen Associate Professor Centre for Nano Science and Engineering Indian Institute of Science, Bangalore - 560012